TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74LCX00F,TC74LCX00FN,TC74LCX00FT

Low-Voltage Quad 2-Input NAND Gate with 5-V Tolerant Inputs and Outputs

The TC74LCX00F/ FN/ FT is a high-performance CMOS 2-input NAND gate. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

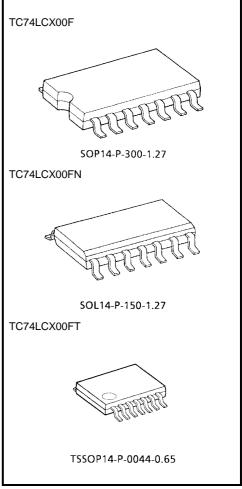
The device is designed for low-voltage (3.3 V) VCC applications, but it could be used to interface to 5 V supply environment for inputs.

All inputs are equipped with protection circuits against static discharge.

Features

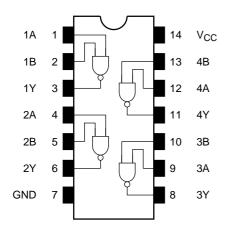
- Low-voltage operation: V_{CC} = 2.0 to 3.6 V
- High-speed operation: $t_{pd} = 5.2 \text{ ns (max) (VCC} = 3.0 \text{ to } 3.6 \text{ V)}$
- Output current: $|I_{OH}|/I_{OL} = 24 \text{ mA (min)} (V_{CC} = 3.0 \text{ V})$
- Latch-up performance: ±500 mA
- Available in JEDEC SOP, JEITA SOP and TSSOP
- · Power-down protection provided on all inputs and outputs
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 00 type

Note: xxxFN (JEDEC SOP) is not available in Japan.



Weight SOP14-P-300-1.27: 0.18 g (typ.) SOL14-P-150-1.27: 0.12 g (typ.) TSSOP14-P-0044-0.65: 0.06 g (typ.)

Pin Assignment (top view)



IEC Logic Symbol

1	&	3 1Y
4		
5		6 2Y
9		8 3Y
13		11 4Y
	9 10 12	2 4 5 9 10 12

Truth Table

Inputs		Outputs
А	В	Y
L	L	Н
L	Н	Н
Н	L	Н
Н	Н	L

Maximum Ratings

Characteristics	Symbol	Rating	Unit
Power supply voltage	Vcc	-0.5 to 7.0	V
DC input voltage	V _{IN}	-0.5 to 7.0	V
		-0.5 to 7.0 (Note 1)	
DC output voltage	V _{OUT}	-0.5 to V _{CC} + 0.5	V
		(Note 2)	
Input diode current	I _{IK}	-50	mA
Output diode current	lok	±50 (Note 3)	mA
DC output current	I _{OUT}	±50	mA
Power dissipation	PD	180	mW
DC V _{CC} /ground current	I _{CC} /I _{GND}	±100	mA
Storage temperature	T _{stg}	-65 to 150	°C

Note 1: $V_{CC} = 0 V$

Note 2: High or low state. $I_{\mbox{OUT}}$ absolute maximum rating must be observed.

Note 3: $V_{OUT} < GND, V_{OUT} > V_{CC}$



Recommended Operating Conditions

Characteristics	Symbol Rating		Unit			
Power supply voltage	V _{CC}	2.0 to 3.6	V			
Fower supply voltage	vcc vcc	1.5 to 3.6 (Note 4)	V			
Input voltage	V _{IN}	0 to 5.5	V			
Output voltage	Vout	0 to 5.5 (Note 5)	٧			
Output voltage	VOU1	0 to VCC (Note 6)	V			
Output current	I _{OH} /I _{OI}	±24 (Note 7)	mA			
Output current	IOH/IOL	±12 (Note 8)	ША			
Operating temperature	T _{opr}	-40 to 85	°C			
Input rise and fall time	dt/dv	0 to 10 (Note 9)	ns/V			

Note 4: Data retention only

Note 5: $V_{CC} = 0 \text{ V}$

Note 6: High or low state

Note 7: $V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$

Note 8: $V_{CC} = 2.7 \text{ to } 3.0 \text{ V}$

Note 9: $V_{IN} = 0.8 \text{ to } 2.0 \text{ V}, V_{CC} = 3.0 \text{ V}$

Electrical Characteristics

DC Characteristics ($Ta = -40 \text{ to } 85^{\circ}\text{C}$)

Characteris	etics	Symbol	Test Condition		Min	Max	Unit	
Onaraciens	51103	Cymbol	1031.0	ondition	V _{CC} (V)	IVIIII	IVIAX	Offic
Input voltage	H-level	V _{IH}	_		2.7 to 3.6	2.0	_	V
input voltage	L-level	V _{IL}	-	_		_	0.8	v
	H-level V _{OH}			I _{OH} = -100 μA	2.7 to 3.6	V _{CC} - 0.2	_	- - V
		Voh	VIN = VIH or VIL	$I_{OH} = -12 \text{ mA}$	2.7	2.2	_	
				$I_{OH} = -18 \text{ mA}$	3.0	2.4		
Output voltage				$I_{OH} = -24 \text{ mA}$	3.0	2.2		
				$I_{OL} = 100 \ \mu A$	2.7 to 3.6	_	0.2	
L-level	V _{OL}	VIN = VIH	$I_{OL} = 12 \text{ mA}$	2.7	_	0.4		
			$I_{OL} = 16 \text{ mA}$	3.0	_	0.4		
				$I_{OL} = 24 \text{ mA}$	3.0	_	0.55	
Input leakage currer	nt	I _{IN}	$V_{IN} = 0$ to 5.5 V	V _{IN} = 0 to 5.5 V		_	±5.0	μΑ
Power off leakage c	urrent	I _{OFF}	$V_{IN}/V_{OUT} = 5.5 V$		0	_	10.0	μΑ
Quiescent supply cu	ırrent	loo	$V_{IN} = V_{CC}$ or GND		2.7 to 3.6	_	10.0	
Quiescent supply co		Icc	$V_{IN} = 3.6 \text{ to } 5.5 \text{ V}$		2.7 to 3.6	_	±10.0	μΑ
Increase in Icc per in	nput	Δlcc	$V_{IH} = V_{CC} - 0.6 \text{ V}$		2.7 to 3.6	_	500	

3



AC Characteristics ($Ta = -40 \text{ to } 85^{\circ}\text{C}$)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Min	Max	Unit
Propagation delay time	t _{pLH}	Figure 1, Figure 2	2.7	_	6.0	ns
	t_{pHL}		3.3 ± 0.3	1.5	5.2	
Output to output skew	t _{osLH}	(Note 10)	2.7	_	_	ns
	t _{osHL}	(Note 10)	3.3 ± 0.3	_	1.0	

Note 10: Parameter guaranteed by design.

 $(t_{OSLH} = |t_{DLHm} - t_{DLHn}|, t_{OSHL} = |t_{DHLm} - t_{DHLn}|)$

Dynamic Switching Characteristics

(Ta = 25°C, input: $t_r = t_f = 2.5 \text{ ns}$, $C_L = 50 \text{ pF}$, $R_L = 500 \Omega$)

Characteristics		Symbol	Test Condition	V _{CC} (V)	Тур.	Unit
Quiet output maximum dynamic	V_{OL}	V _{OLP}	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	8.0	V
Quiet output minimum dynamic	V_{OL}	V _{OLV}	$V_{IH} = 3.3 \text{ V}, V_{IL} = 0 \text{ V}$	3.3	8.0	V

Capacitive Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Тур.	Unit
Input capacitance	C _{IN}	_		3.3	7	pF
Output capacitance	C _{OUT}	_		0	8	pF
Power dissipation capacitance	C _{PD}	$f_{IN} = 10 \text{ MHz}$ (Not	e 11)	3.3	25	pF

Note 11: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/4 \text{ (per gate)}$

AC Test Circuit

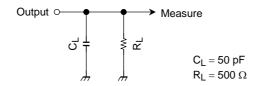


Figure 1

AC Waveform

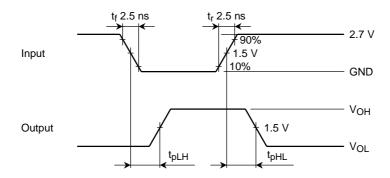
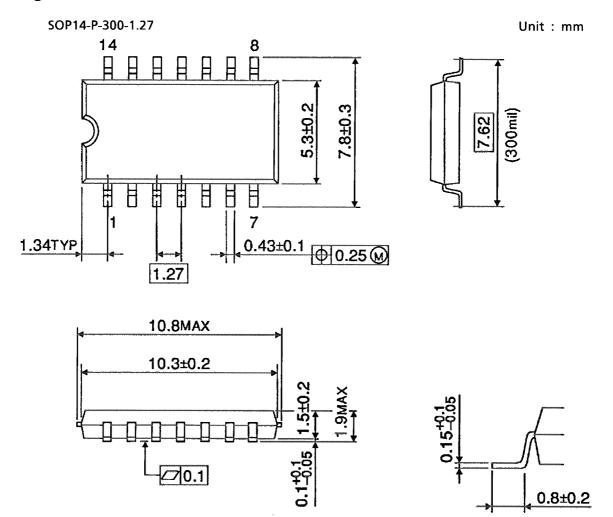


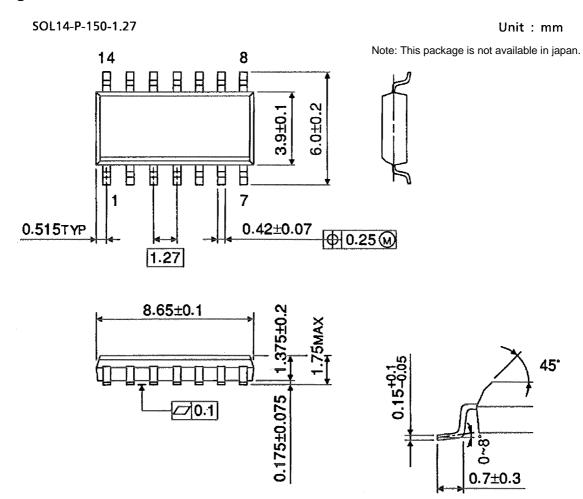
Figure 2 t_{pLH}, t_{pHL}

Package Dimensions



Weight: 0.18 g (typ.)

Package Dimensions

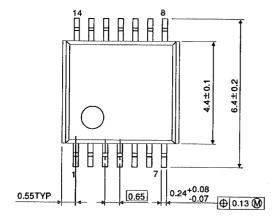


Weight: 0.12 g (typ.)

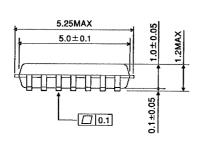
Unit: mm

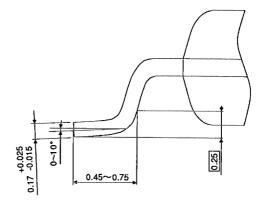
Package Dimensions

TSSOP14-P-0044-0.65









Weight: 0.06 g (typ.)

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